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UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT(S)	Lup Kweun Yee	GROUP ART UNIT:	3729
APPLN. NO.:	10/077,538	EXAMINER:	Carl J. Arbes
FILED:	February 15, 2002		
TITLE:	PROCESS FOR DISENGAGING SEMICONDUCTOR DIE FROM AN ADHESIVE FILM (as amended)		

Certificate of Transmission under 37 CFR 1.8

I hereby certify that this correspondence is being facsimile transmitted to the Patent and Trademark Office on April 12, 2004

 PAT THOMAS
Pat Thomas

RESPONSE TO OFFICE ACTION

Mail Stop Non-Fee Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Responsive to the Office Action dated February 11, 2004, this paper being timely filed on April 12, 2004 in view of April 11, 2004 occurring on a Sunday, please enter the following amendments in the above-identified application, without prejudice or disclaimer.

Amendment to the Title begins on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Remarks/Arguments begin on page 5 of this paper.